

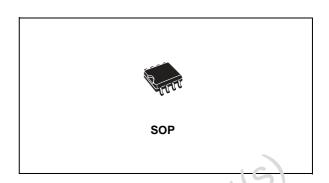
STLVDS9637

HIGH SPEED DIFFERENTIAL LINE RECEIVERS

- MEETS OR EXCEEDS THE REQUIREMENTS OF ANSI TIA/EIA-644 STANDARD
- OPERATES WITH A SINGLE 3.3V SUPPLY
- DESIGNED FOR SIGNALING RATE UP TO 400Mbps
- DIFFERENTIAL INPUT THRESHOLDS ±100mV MAX
- TYPICAL PROPAGATION DELAY TIME OF 2.5ns
- POWER DISSIPATION 60mW TYPICAL PER RECEIVER AT 200MHz
- LOW VOLATGE TTL (LVTTL) LOGIC OUTPUT LEVELS
- OPEN CIRCUIT FAIL SAFE
- ESD PROTECTION:
 7KV RECEIVER PINS
 3KV ALL PINS VS GND



The STLVDS9637, is a differential line receiver that implements the electrical characteristics of low voltage differential signaling (LVDS). This signaling technique lowers the output voltage levels of 5V differential standard levels (such as TIA/EIA-422B) to reduce the power, in crease the switching speeds and allow operations with a 3.3V supply rail. This differential receiver provides a



valid logical output state with a 3.50 supply rail. It also provides a valid logical output state with a ±100mV differential input voltage within the input common mode voltage range. The input common mode voltage allows 1V of ground potential difference between two LVDS nodes.

The intended application of this device and signalling technique is both point-to-point and multicrop data transmission over controlled impedance media approximately 100Ω . The transmission media may be printed circuit board traces, backplanes or cables. The ultimate rate and distance of data transfer depend upon the attenuation characteristics of the media and noise coupling to the environment.

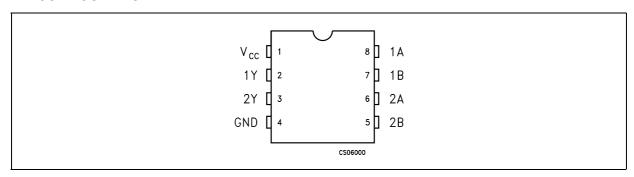
The STLVDS9637 version is characterized for operation from -40°C to 85°C.

ORDERING CODES

Туре	Temperature Range	Package	Comments	
STLVDS9(3 BD	-40 to 85 °C	SO-8 (Tube)	100parts per tube / 40tube per box	
STLVNS J637BDR	-40 to 85 °C	SO-8 (Tape & Reel)	2500 parts per reel	

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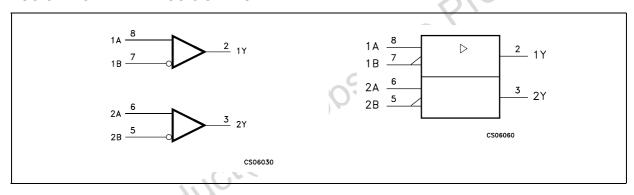
PIN CONFIGURATION



PIN DESCRIPTION

PIN N°	SYMBOL	NAME AND FUNCTION
2, 3	1Y to 2Y	Receiver Outputs
5, 7	1B to 2B	Negated Receiver Inputs
6, 8	1A to 2A	Receiver Inputs
4	GND	Ground
1	V _{CC}	Supply Voltage

LOGIC DIAGRAM AND LOGIC SYMBOL



TRUTH TABLE

DIFFERENTIAL INPUTS	OUTPUT
A, B	Y
V _{ID} ≥ 100mV	Н
-100mV < V _{ID} < 100mV	?
V _{ID} ≤ -100mV	L
OPEN	Н

L = Low level, H = High Level, X = Don't care, Z = High Impedance, ? = Indeterminate

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit	
V _{CC}	Supply Voltage (Note 1)	-0.5 to 4.6	V	
VI	Input Voltage	-0.5 to (V _{CC} + 0.5)	V	
V _I	Input Voltage (A or B inputs)		-0.5 to 4.6	V
ECD	ESD Human Body Model Pins Receivers All Pins vs GND		7	KV
ESD			3	ΚV
T _{stg}	Storage Temperature Range		-65 to +150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

Note 1: All voltages except differential I/O bus voltage, are with respect to the network ground terminal.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min.	Тур.	Max.	Unit
V _{CC}	Supply Voltage	3.0	3.3	3.6	V
V _{IH}	HIGH Level Input Voltage (ENABLE)	2.0		10	V
V _{IL}	LOW Level Input Voltage (ENABLE)			0.8	V
V _{ID}	Magnitude of Differential Input Voltage	0.1		0.6	V
V _{IC}	Common Mode Input Voltage	0.5 V _{ID}	~C	2.4-0.5 V _{ID}	V
			10	V _{CC} - 0.8	
T _A	Operating Temperature Range	-40		85	°C

ELECTRICAL CHARACTERISTICS (Over recommended operating conditions unless otherwise noted. All typical values are at $T_A = 25$ °C, and $V_{CC} = 3.3$ V)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{ITH+}	Positive Going Differential Input Voltage Threshold				100	mV
V _{ITH-}	Negative Going Differential Input Voltage Threshold	15	-100			mV
V _{OH}	High Level Output Voltage	I _{OH} = -8mA	2.4			V
		I _{OH} = -4mA	2.8			
V _{OL}	Low Level Output Voltage	I _{OH} = 8mA			0.4	V
Icc	Supply Current	No Load		4	10	mA
II	Input Current (A or B inputs)	$V_I = 0V$	-2	-10	-20	μΑ
	160	V _I = 2.4V	-1.2	-3		
I _{I(OFF)}	Power off Input Current (A or B inputs)	$V_{CC} = 0$ $V_1 = 3.6V$		10	20	μΑ
J _H	High Level Input Current (EN, G, G or Inputs)	V _{IH} = 2V			10	μΑ
I _{IL}	Low Level Input Current (EN, G, G or Inputs)	V _{IL} = 0.8V			10	μΑ
I _{OZ}	High Impedance Output Current	$V_O = 0$ or V_{CC}			± 10	μΑ

SWITCHING CHARACTERISTICS (Unless otherwise noted. Typical values are referred to $T_A = 25$ °C and $V_{CC} = 3.3V$)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{PLH}	Propagation Delay Time, Low to High Output	C _L = 10pF Fig. 1	1.5	2.5	3.3	ns
t _{PHL}	Propagation Delay Time, High to Low Output		1.5	2.5	3.3	ns
t _r	Differential Output Signal Rise Time			0.4		ns
t _f	Differential Output Signal Fall Time			0.4		ns
t _{sk(O)}	Channel to Channel Output Skew (note1)			0.1	0.3	ns
t _{sk(P)}	Pulse Skew (t _{PHL} - t _{PLH}) (note2)			0.2	0.4	ns
t _{sk(PP)}	Part to Part Skew (note3)				1	ns
t _{PZH}	Propagation Delay Time, High Impedance to High Level Output	Fig. 2		3	12	ns
t _{PZL}	Propagation Delay Time, High Impedance to Low Level Output			5	12	ns
t _{PHZ}	Propagation Delay Time, High Level to High Impedance Output		61,	5	12	ns
t _{PLZ}	Propagation Delay Time, Low Level to High Impedance Output	dete		5	12	ns

Note 1: $t_{sk(O)}$ is the maximum delay time difference between the propagation delay of one channel and that of the others on the same chip with any event on the inputs.

Note 2: $t_{sk(P)}$ is the magnitude difference in differential propagation delay time between the positive going edge and the negative going edge of the same channel.

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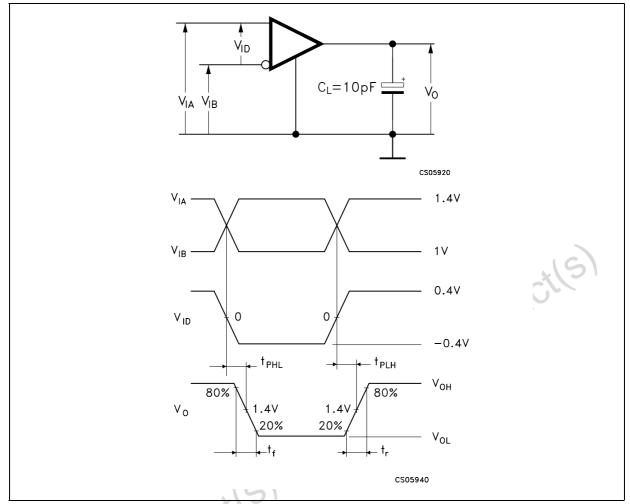
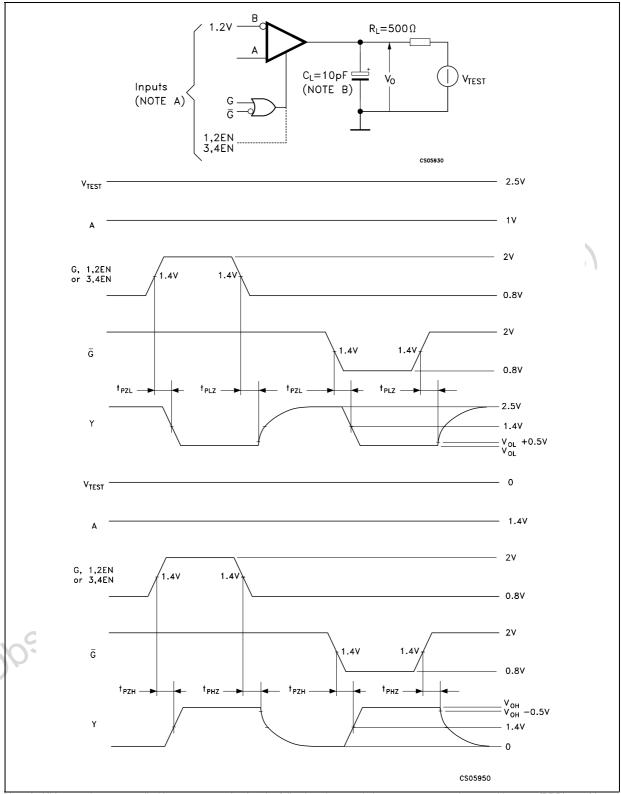


Figure 1 : Timing Test Circuit, Timing And Waveforms

Note A: All input pulse are supplied by a generator having the following characteristics: t_r or $t_f \le 1$ ns, pulse repetition rate (PRR) = 50Mpps, pulse width = 10 ± 0.2 ns. Note B: C_L includes instrumentation and fixture capacitance within 6mm of the D.U.T.

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Figure 2: Enable And Disable Time Test Circuit And Waveform

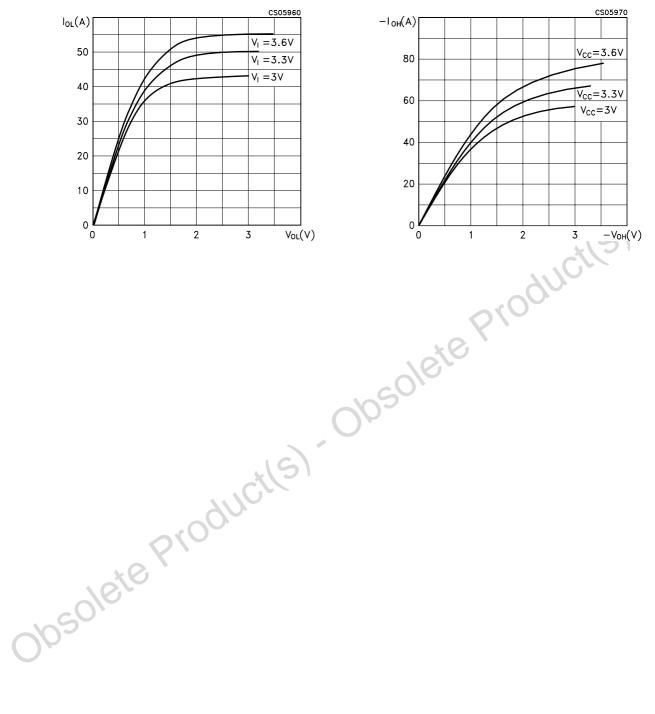


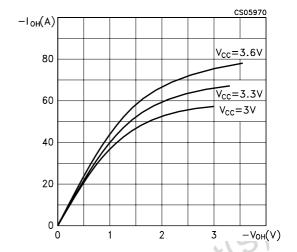
Note A: All input pulse are supplied by a generator having the following characteristics: t_r or $t_f \le 1$ ns, pulse repetition rate (PRR) = 50Mpps, pulse width = 500 ± 1 0ns. Note B: C_L includes instrumentation and fixture capacitance within 6mm of the D.U.T.

TYPICAL PERFORMANCE CHARACTERISTICS (unless otherwise specified T_i = 25°C)

Figure 3: Output Current vs Output Voltage

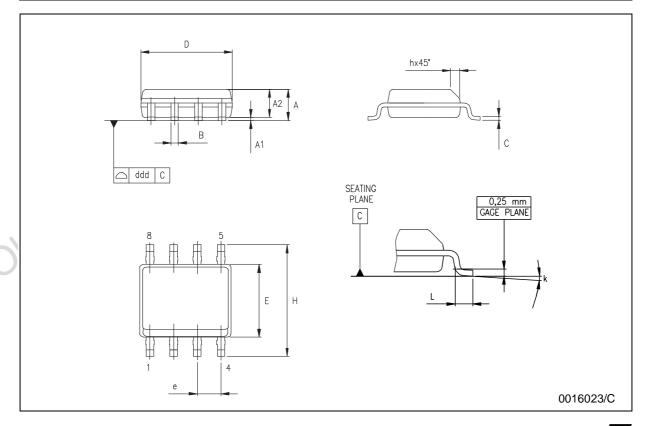
Figure 4 : Output Current vs Output Voltage





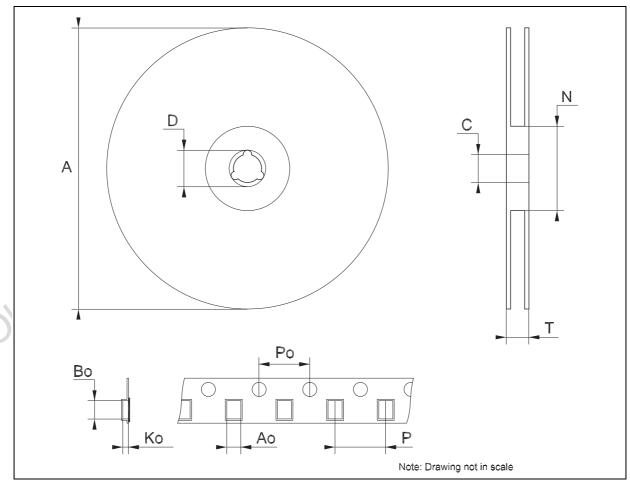
SO-8 MECHANICAL DATA

DIM.		mm.		inch		
DIIVI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
В	0.33		0.51	0.013		0.020
С	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
е		1.27			0.050	
Н	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	8° (max.)					
ddd			0.1			0.04



Tape & Reel SO-8 MECHANICAL DATA

DIM.	mm.			inch			
DIWI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
А			330			12.992	
С	12.8		13.2	0.504		0.519	
D	20.2			0.795			
N	60			2.362			
Т			22.4			0.882	
Ao	8.1		8.5	0.319		0.335	
Во	5.5		5.9	0.216		0.232	
Ko	2.1		2.3	0.082		0.090	
Po	3.9		4.1	0.153		0.161	
Р	7.9		8.1	0.311		0.319	



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